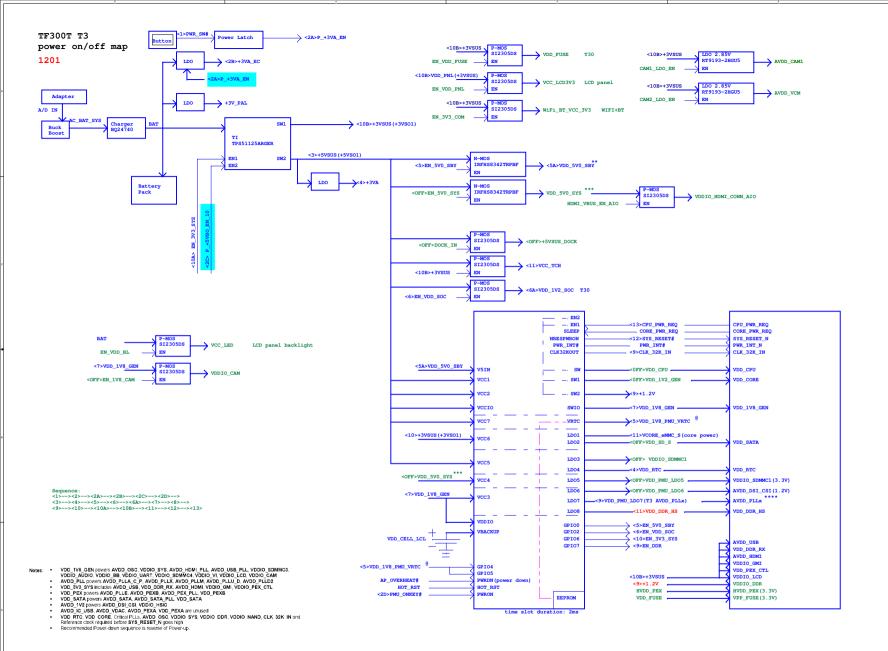
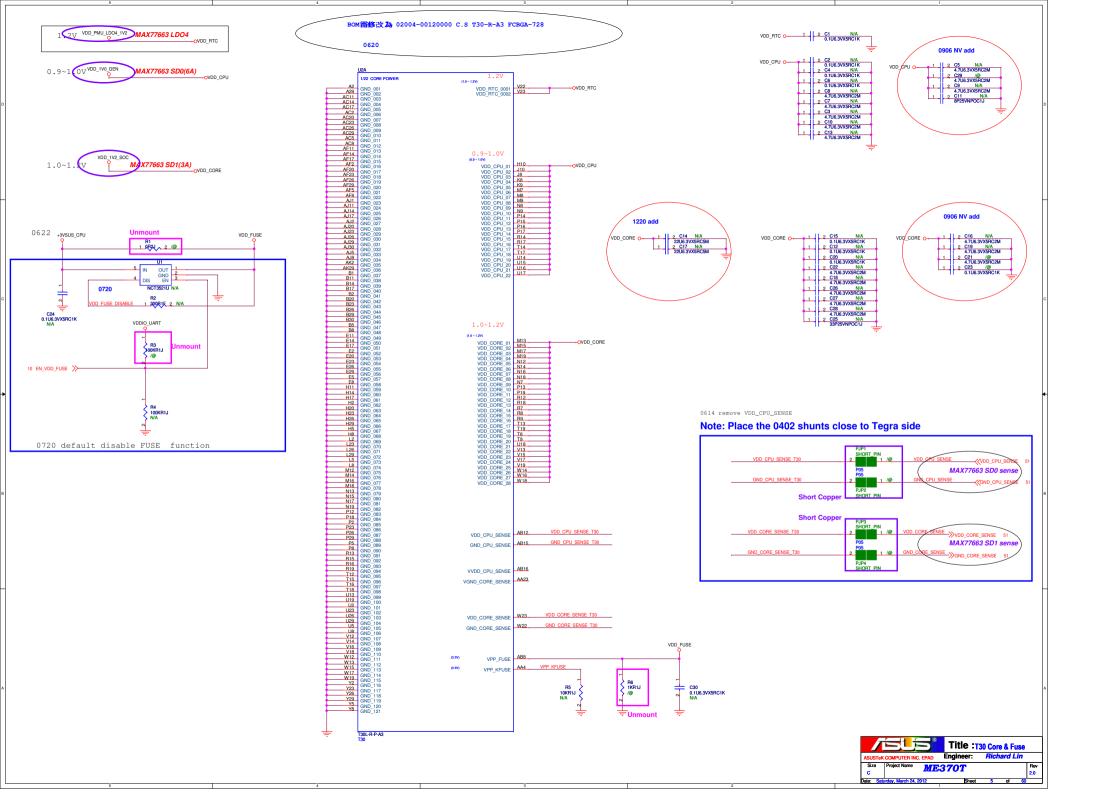
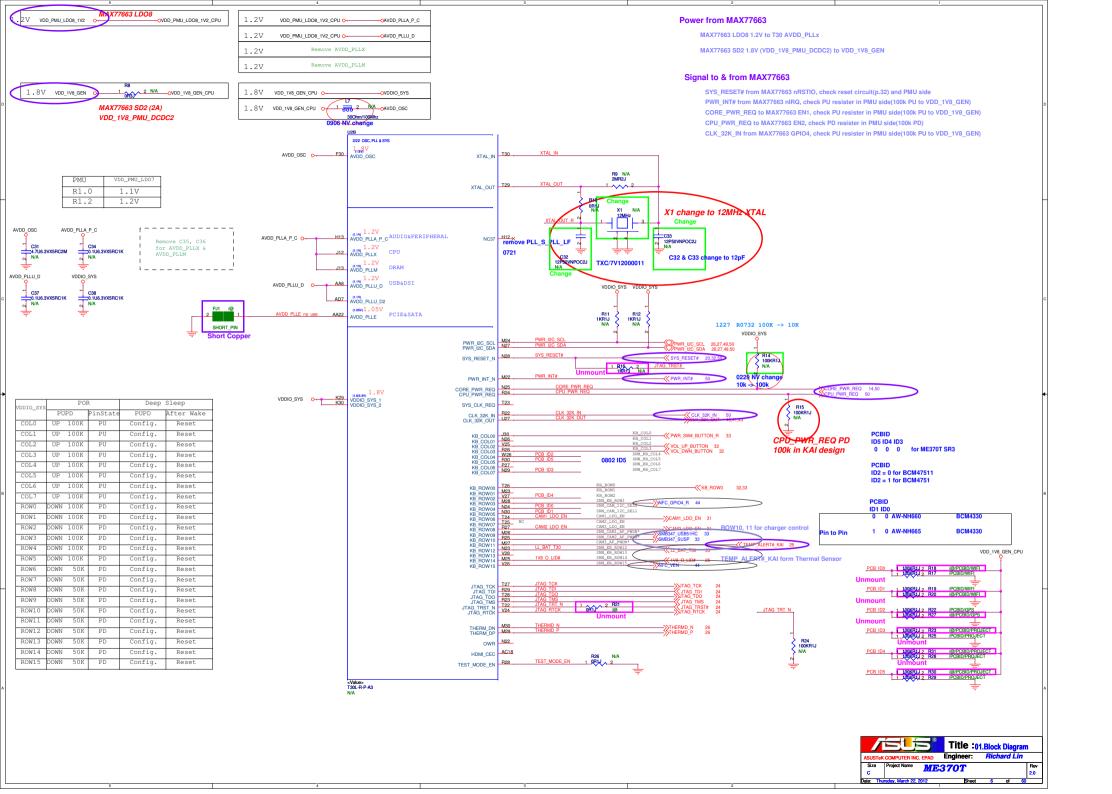


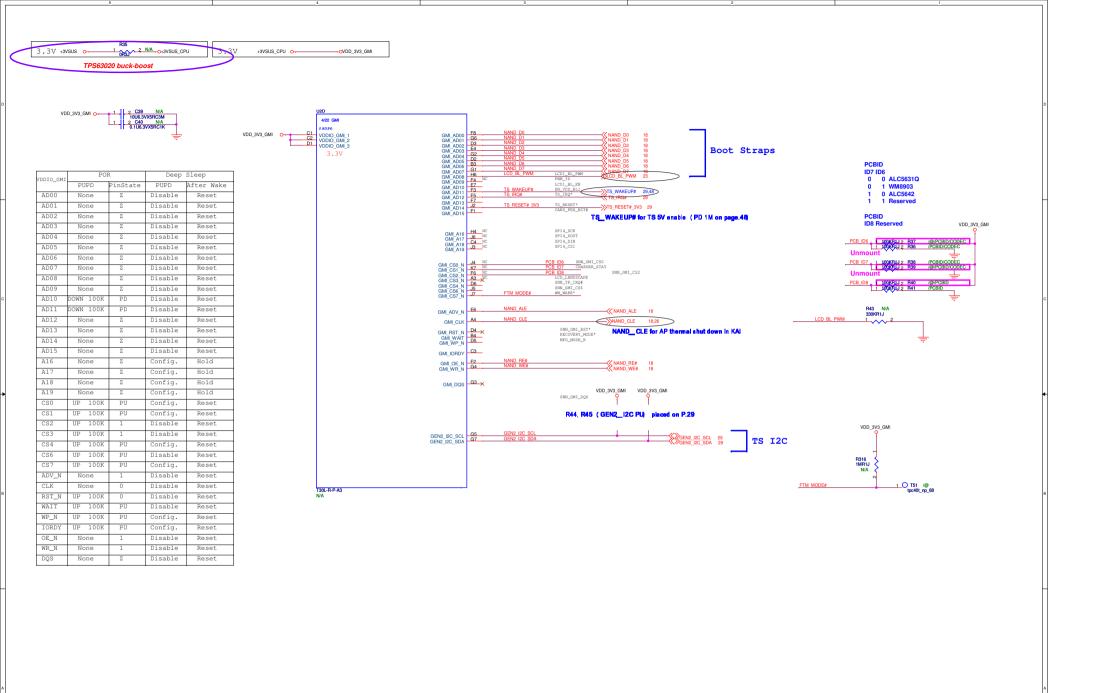
TF300T_T3 Power On/Off			
		<u> </u>	
	A/D_IN		
	AC_BAT_SYS	3.3V	
	AC_OK	3.3V	
	+3VA_PAL (PU8805)	3.3V	
	PWR_SW#	3.3V	
	+3VA_EC (PU8806)		
EC to PU8100	P_+5VSO_EN_10 (Q7900)	AC_BAT_SYS	
	+5VSUS (PU8100)	5v	
		1.80	
	VDD_1V8_PMU_VRTC(PMU_VRTC)	2 277	
SW# to PMU	PMU_ONKEY#	3.3V	c
	EN_5V0_SBY(PMU GPIO0)	1.8V	
	VDD_5V0_SBY (PQ9106, 2A)	5V	
	VDD_RTC (PMU LDO4)	1.8V	
PMU to T3	VDD_1V8_GEN (PMU SWIO)	1.2V	
PMU to T3	VDD_CORE (PMU_SW1)	1.1V	•
PMU to T3	VDD_PMU_LDO7(T3 AVDD_PLLx)		
PMU to T3	CLK_32K_IN (PMU)		
T3 XTAL	System Clock(T3 26MHz)	5.0v	
	EN_VDD_1V35 (EN_DDR, PMU GPIO7)	1.8V	
	+1.8V	1.35V	В
	+1.2V(for DDR3L 1.35V)		
PMU to PU8100	EN_3V3_SYS(PMU GPIO6)	5.0V	
T3 to Q1603	EN_3V3_EMMC (T3)	1.8V	
	VCORE_eMMC_S (Q1603)	2.85V	
PMU to T3	VDD_DDR_HS(PMU LDO8) 1.0V	1 05	H
PMU to T3	VDD_SATA (PMU LDO2)	1.05V	
PMU to T3	VDD_PEX(PMU LDO1) (EEPROM OFF)	1.05V 1.8V	
PMU to T3	SYS_RESET# (PMU)	1.8V	
T3 to PMU	CPU_PWR_REQ (TERGA)		A
PMU to T3	VDD_CPU(PMU SW)	1.00	
	OTHERS (PMU LDOs, Switched Rails)	+1.05VS/+1.2VS/+1.5VS	
		Title : Timing	,
		ABUSTAN COMPUTER No. EPAD Engineer: Rik Sara Projet Narra MIES 70T	Chard Lin
5	4 3	Date: Thursday, March 01, 2012 Sheet 3	of 60



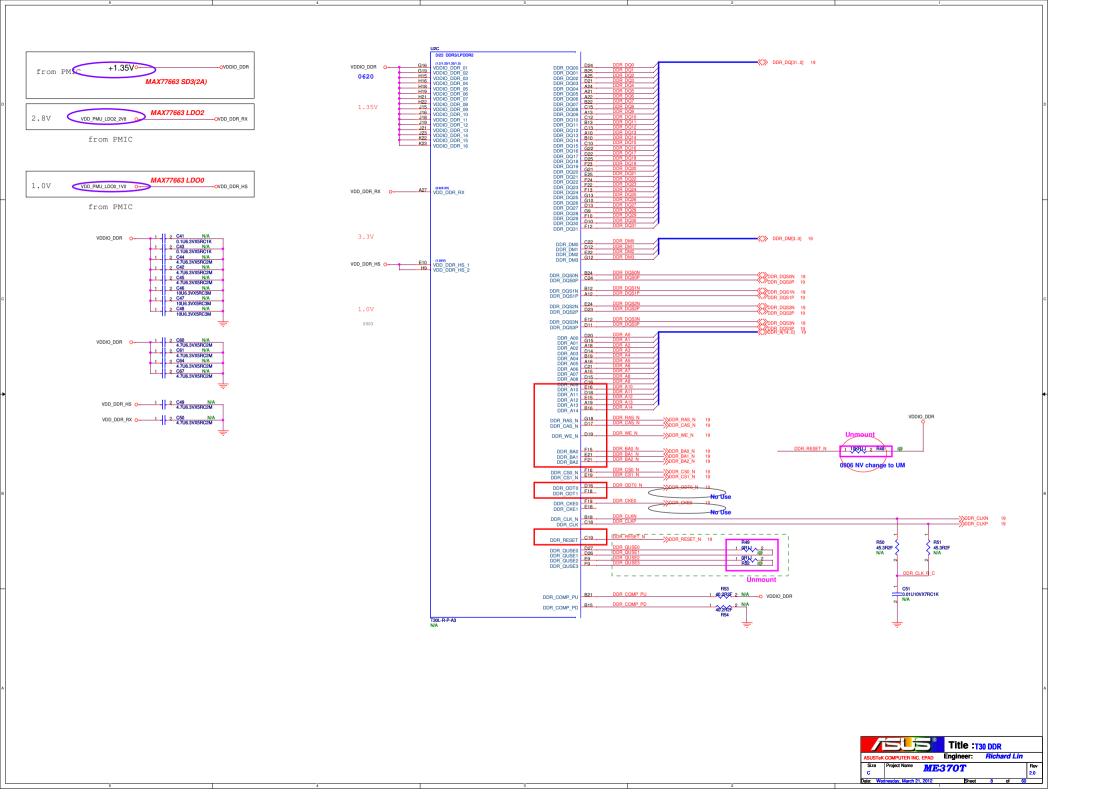


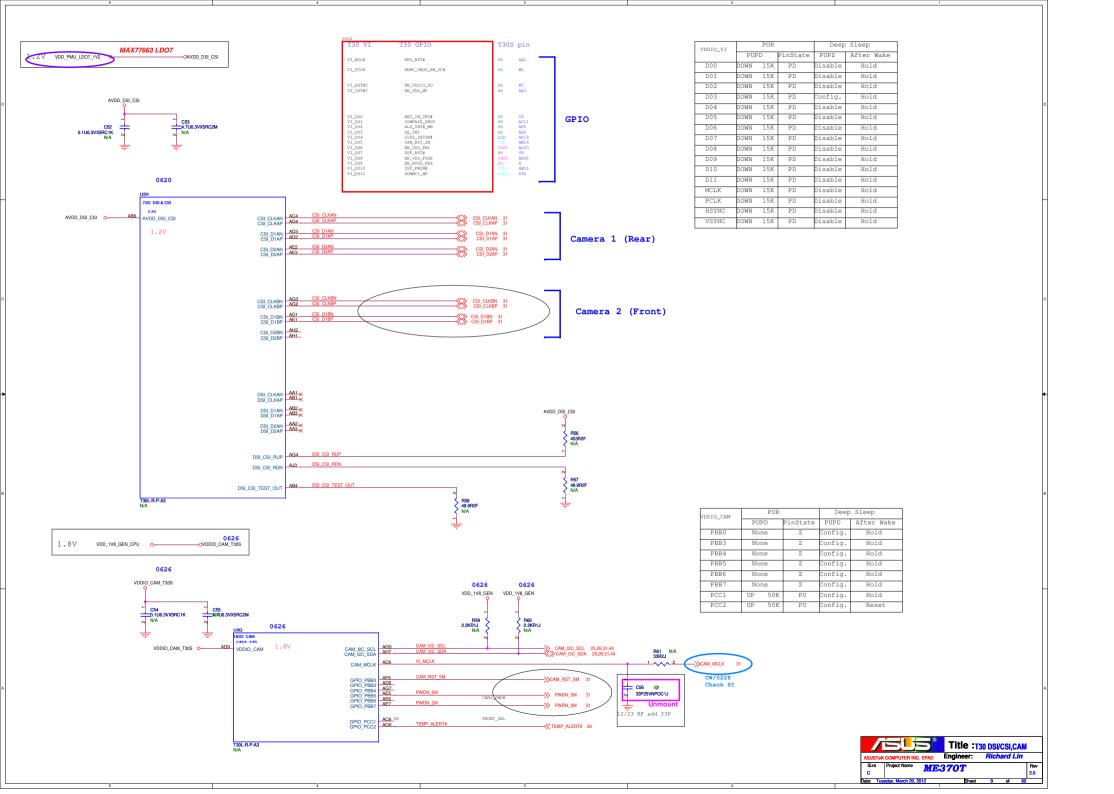


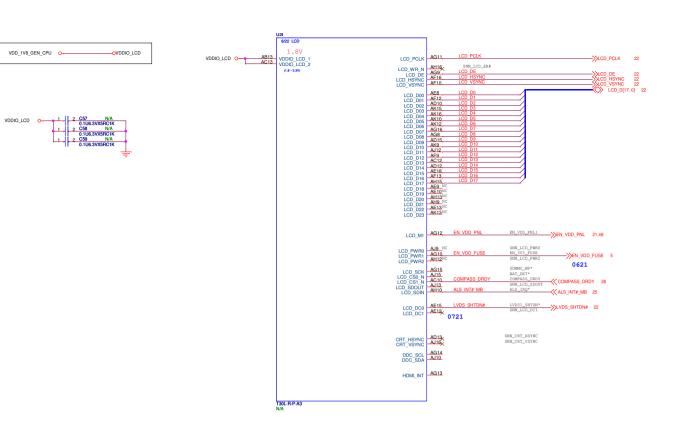










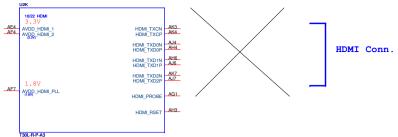


1.8V

DDIO LCD		POR		Deep	Sleep
DDIO_BCD	PUF	D	PinState	PUPD	After Wake
LCD_M1	DOWN	100K	PD	Disable	Hold
LCD_PWR0	DOWN	100K	PD	Disable	Hold
LCD_PWR1	DOWN	100K	PD	Disable	Hold
LCD_PWR2	DOWN	100K	PD	Disable	Hold
LCD_SCK	UP	100K	PU	Disable	Hold
LCD_CSO_N	UP	100K	PU	Disable	Hold
LCD_CS1_N	UP	100K	PU	Disable	Hold
LCD_SDOUT	UP	100K	PU	Disable	Hold
LCD_SDIN	UP	100K	PU	Disable	Hold
LCD_DC0	DOWN	100K	PD	Disable	Hold
LCD_DC1	DOWN	100K	PD	Disable	Hold

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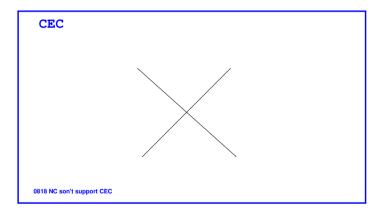




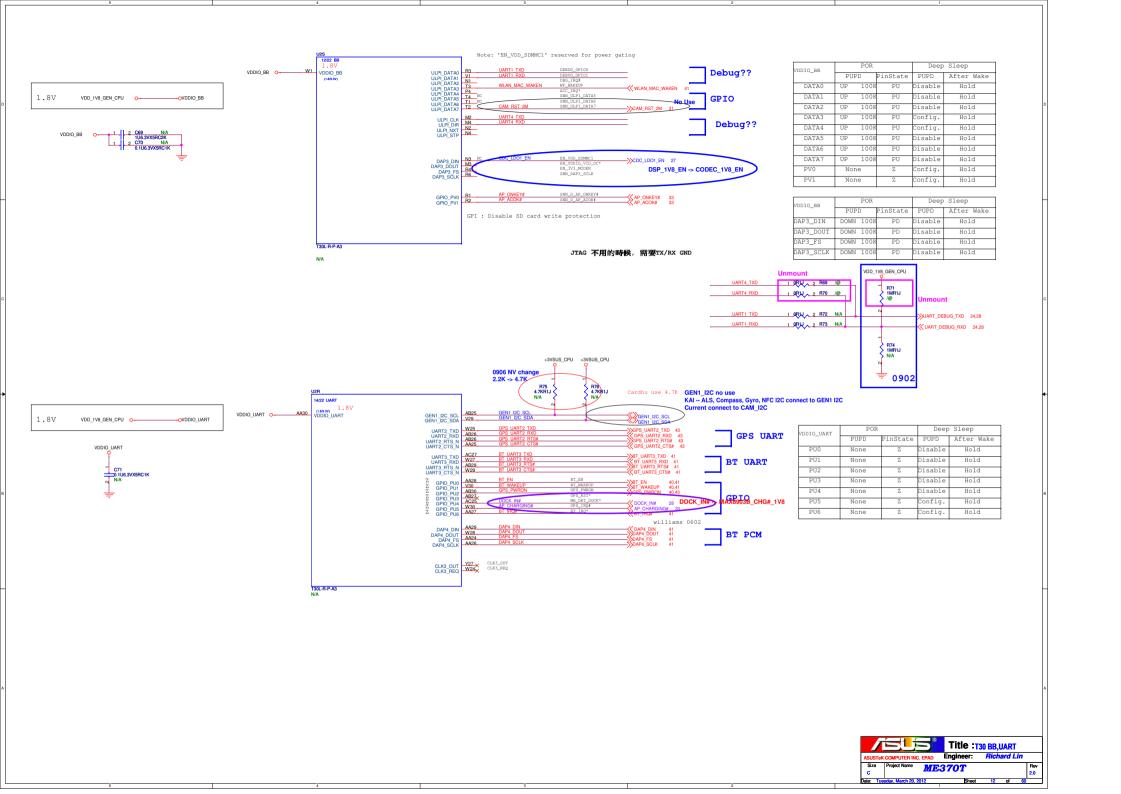
All HDMI pins & powers leave NC when HDMI is not be used.

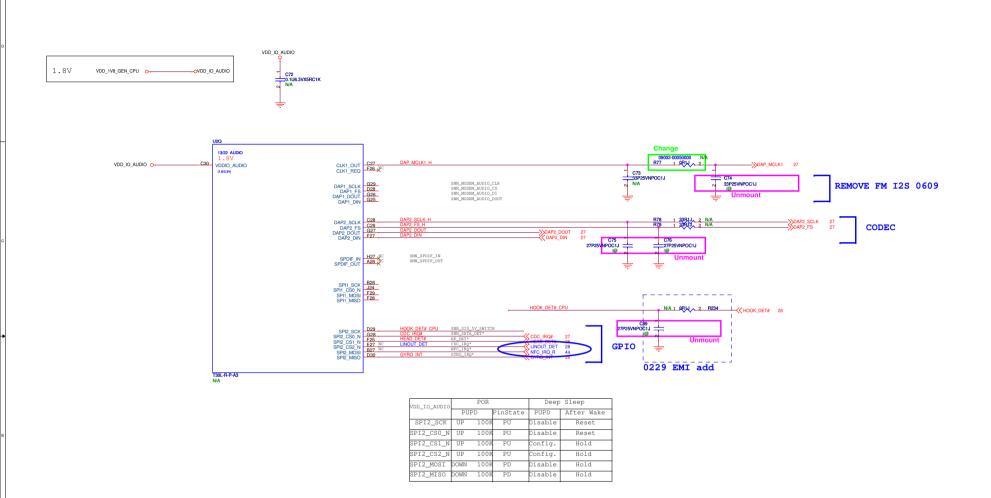


All VDAC pins & powers leave NC

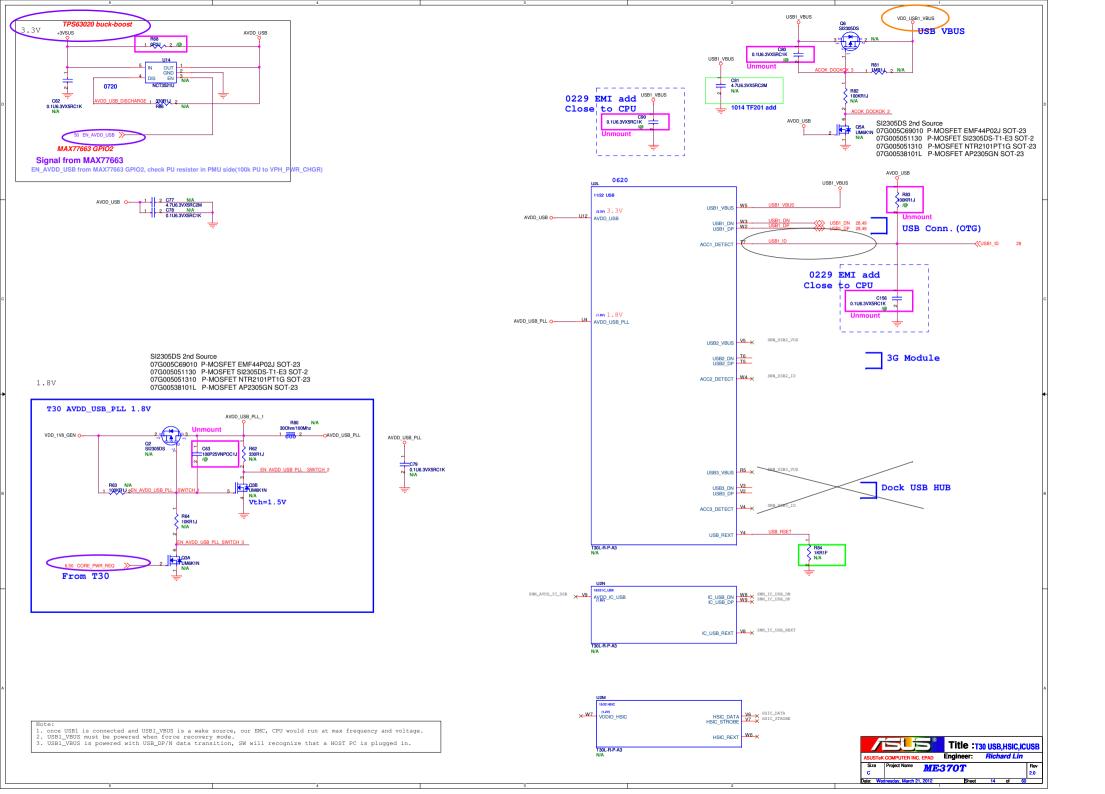


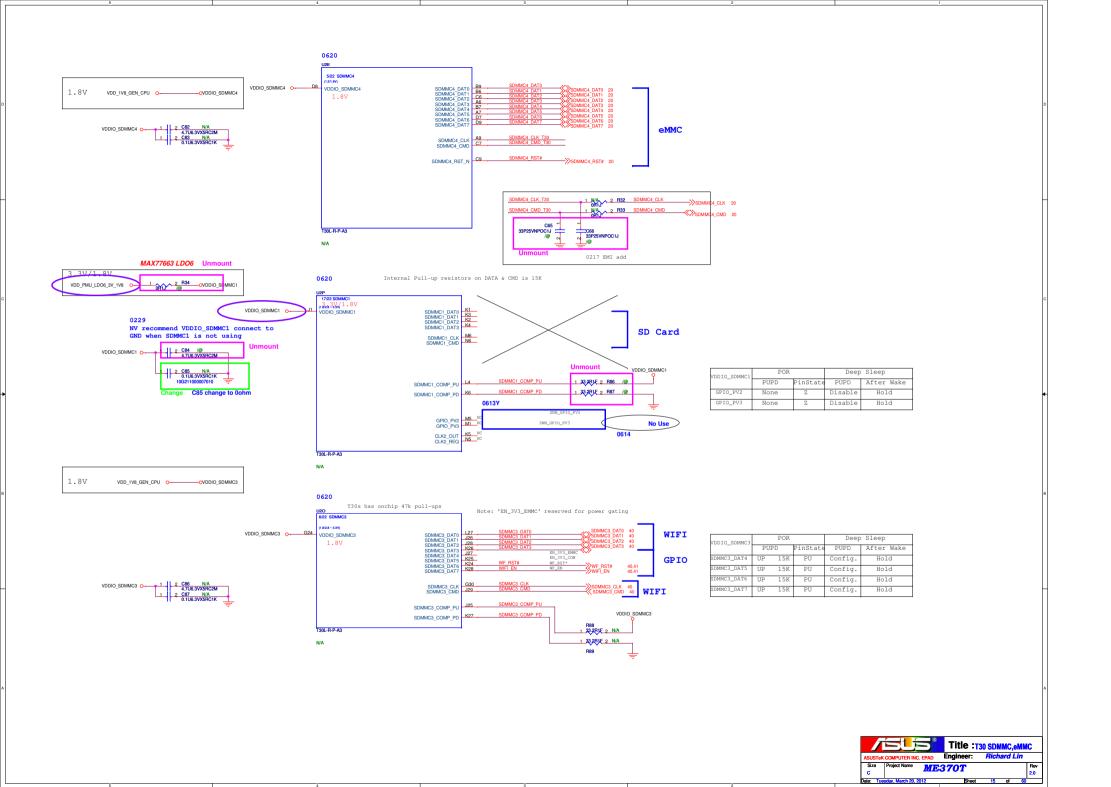


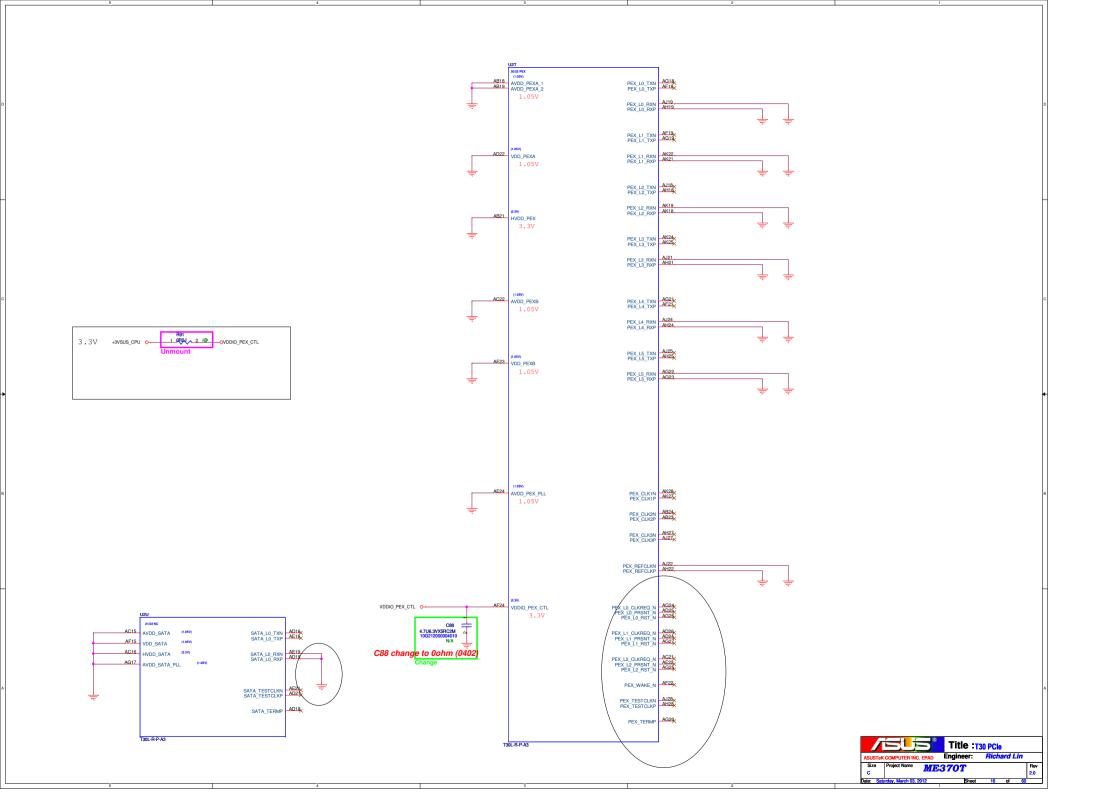


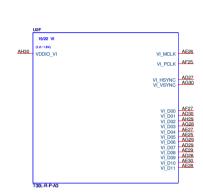


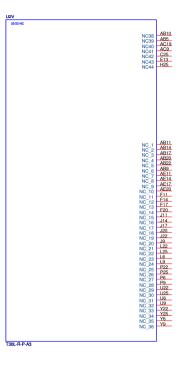




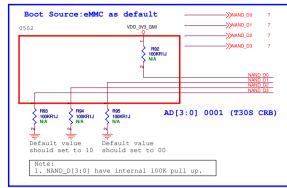


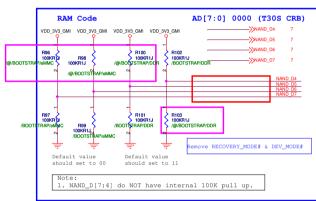


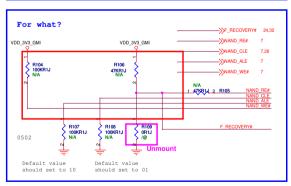




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AD3	AD2	AD1	AD0	Determine Boot Device to be config.
0	0	0	0	eMMC primary x4
0	0	0	1	eMMC primary x8
0	0	1	0	eMMC secondary x4
0	0	1	1	NAND
0	1	0	0	NAND w/ block & page offset=1
0	1	0	1	Mobile LBA NAND
0	1	1	0	FlexMuxOneNAND
0	1	1	1	eSD x4
1	0	0	0	SPI Flash
1	0	0	1	SNOR (Muxed, x16)
1	0	1	0	SNOR (Muxed, x32)
1	0	1	1	SNOR (Non-Muxed, x16)
1	1	0	0	MuxOneNAND
1	1	0	1	SATA
1	1	1	0	eMMC secondary x8
1	1	1	1	Use fuse data
	-			YM 0502

DG05576900 V1.3 P75

		AD5	AD4		Seled			
	SKU1&3	0	0	ELPIDA	DDR3LRS	256MBx4	EDJ2108EDBG-DJL-F	03006-00030900
	SKU2&4	0	1	Hynix	DDR3LM	256MBx4	H5TC2G83CFR-H9R	03006-00031200
-		1	0	TBD				
		1	1	TBD				
	20120302							

R100	R101	R102	R103
	V		V
	V	V	
V			V
V		V	

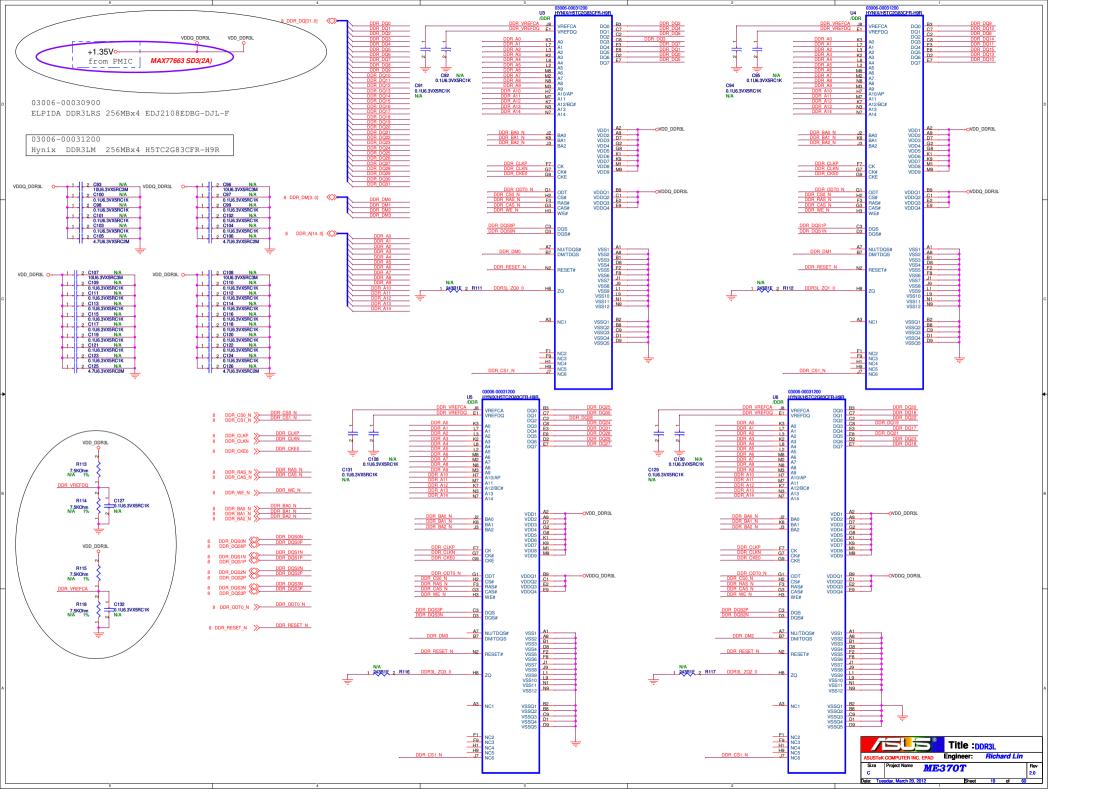
	AD7	AD6	S∈	elect eMM	IC Type		
SKU1&2	0	0	HYNIX	8GB	H26M42001FMR	FBGA-153	03100-00120000
SKU3&4	0	1	Kingston	8GB	KE44B-26BN	FBGA169	05G002514010
	1	0	TBD				
	1	1	TBD				

R96	R97	R98	R99	
	7.7		7.7	
	V		V	
	V	V		
V			V	
V		V		

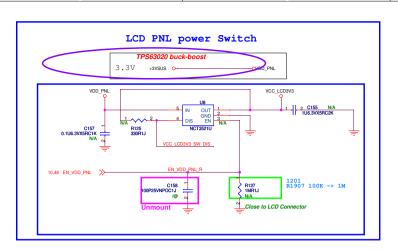
NAND_CLE	NAND_ALE	Description	
0	0	Serial JTAG chain, MPCORE and AVI	•
0	1	MPCore only JTAG	
1	0	AVP only JTAG	
1	1	Reserved	

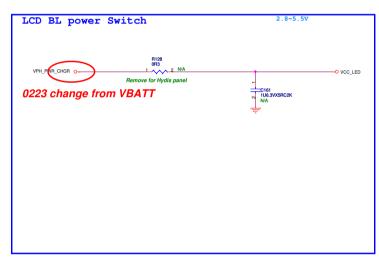
RECOVERY	Description
0	USB Recovery Mode
1	Boot from secondary device



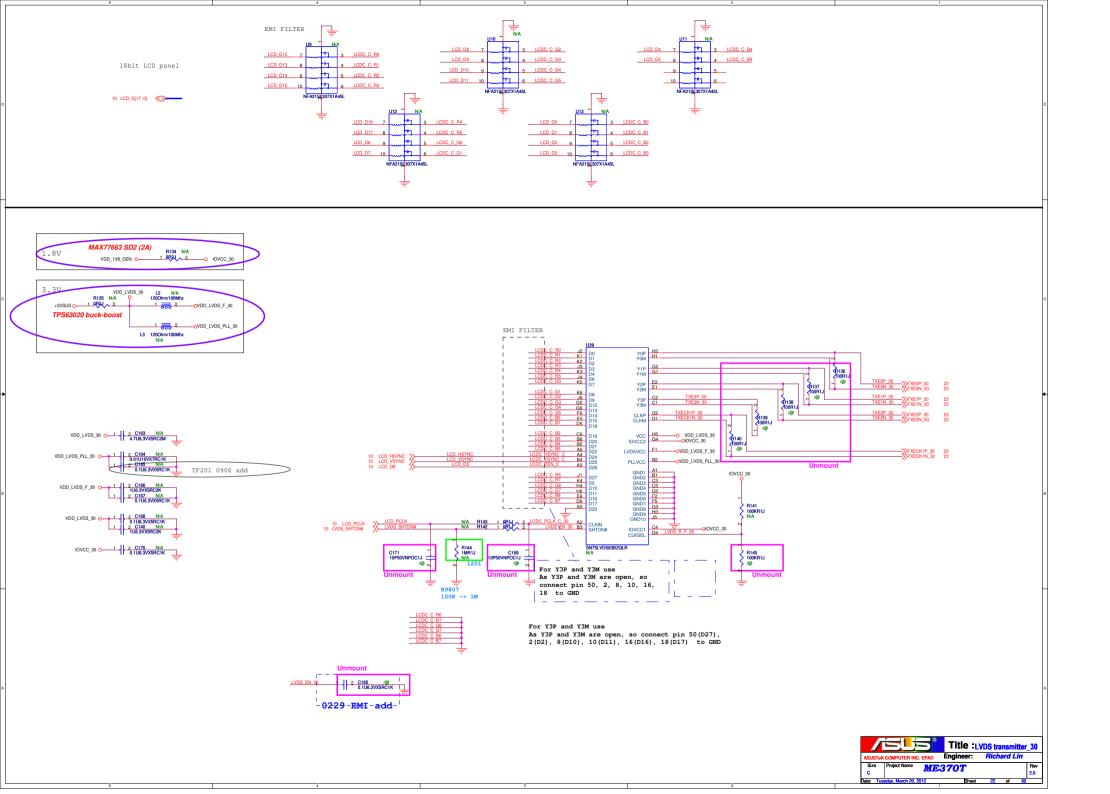


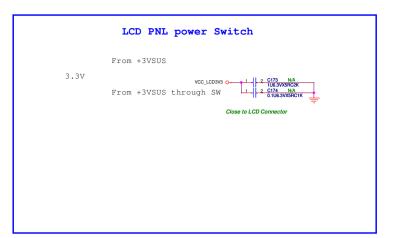
eMMC I/F MAX77663 SD2 (2A) L.8V VDD_1V8_GEN 0906 NV add HYNIX 8GB H26M42001FMR FBGA-153 1 2 C133 N/A 1U6.3VX5RC2K 2 C135 N/A 0.1U6.3VX5RC1K 1 2 C134 N/A 1U6.3VX5RC2K 2 C136 N/A 0.1U6.3VX5RC1K VDDIO HSMMC O-05G002514010 1 2 C137 N/A 0.1U6.3VX5RC1K Kingston 8GB KE44B-26BN FBGA169 MAX77663 LDO3 VDD_PMU_LDO3_2V8 OVCORE_eMMC_S 0906 NV add 1 2 C152 N/A 1U6.3VX5RC2K 1 2 C153 N/A 0.1U6.3VX5RC1K VCORE eMMC S YM 0502 DG05576900 V1.3 P63 1 2 C151 N/A 0.1U6.3VX5RC1K CW/0320 Change to 4.7K by Cardhu. VDDIO_HSMMC R120 4.7KR1 SDMMC4_RST# SDMMC4_RST#_eMMC R402 /@ SDN MC4 RST# eMMC 70 0R1J N/A R403 6,32,50 SYS RESET# >>-KAI ref. design EMI C144 C149
33P25VNPOCIJ 33P25VNPOCIJ 33P25VNPOCIJ 35P25VNPOCIJ 35P25VNPOCIJ UV C146 C148 C142 C144
S3P25VNPOCIJ S3P25VNPOCIJ S3P25VNPOCIJ S3P25VNPOCIJ S3P25VNPOCIJ S3P25VNPOCIJ S3P25VNPOCIJ UTB (eMMC) (eMMC 1174 DAT7 VCC0 VCC1 VCC2 VCC3 VCORE eMMC SC K6 W4 Y4 VCCQ1 VCCQ2 VCCQ2 VCCQ3 VCCQ4 VSSQ0 VSSQ1 VSSQ2 VSSQ3 VSSQ4 VDDIO HSMMC O-VCCL EMMC VCCI C154 Title :eMMC 2.2U6.3VX5RC2M Engineer: Richard Lin Footprint 12x16_14x18 colay **ME370T** 03100-00120000

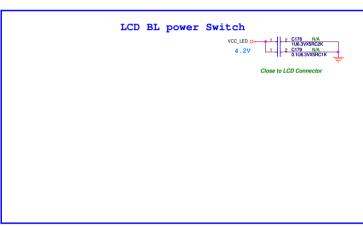


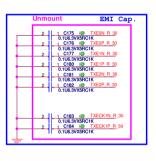


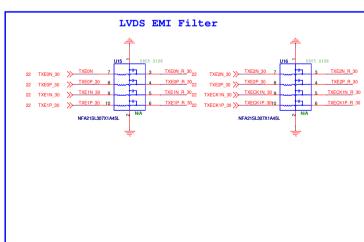


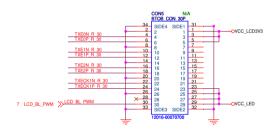






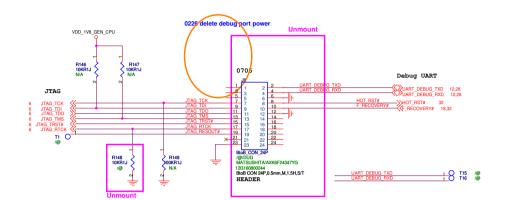






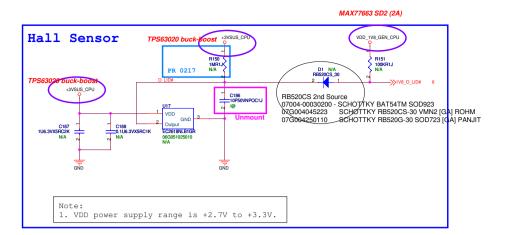
CON5 2nd source MATSUSHITA/AXT530124 12G161H00307



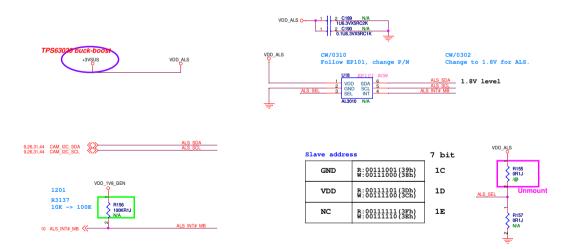


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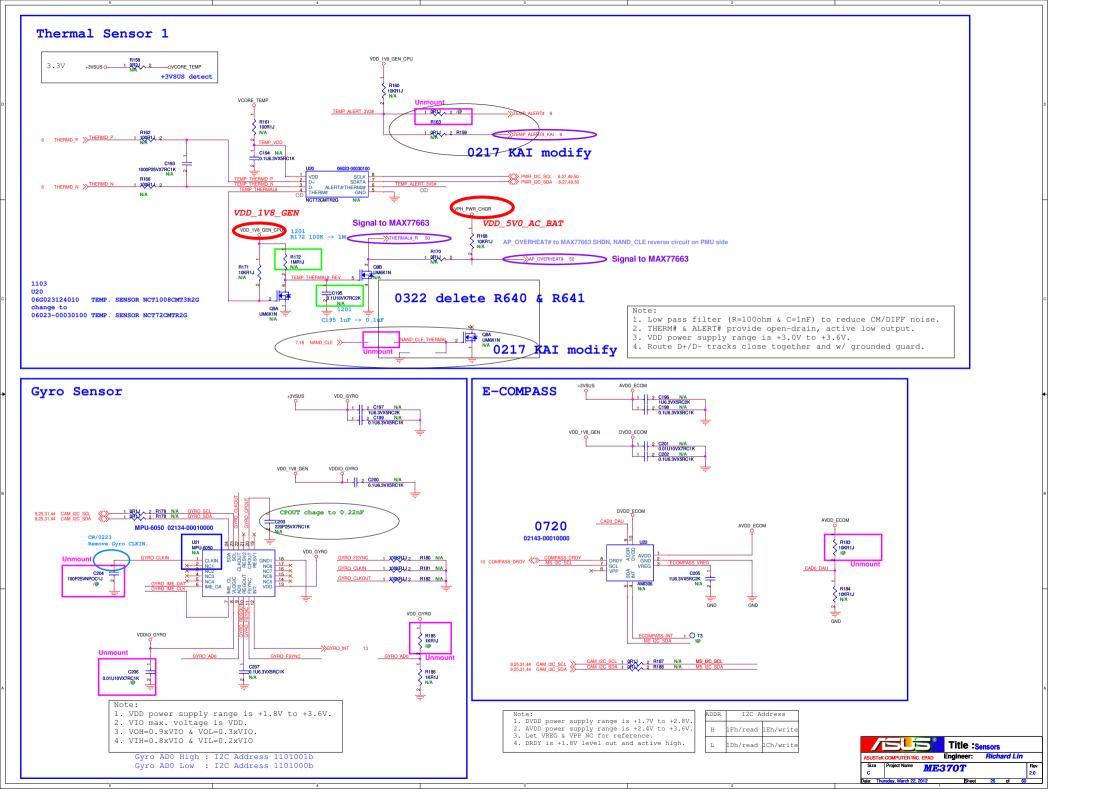
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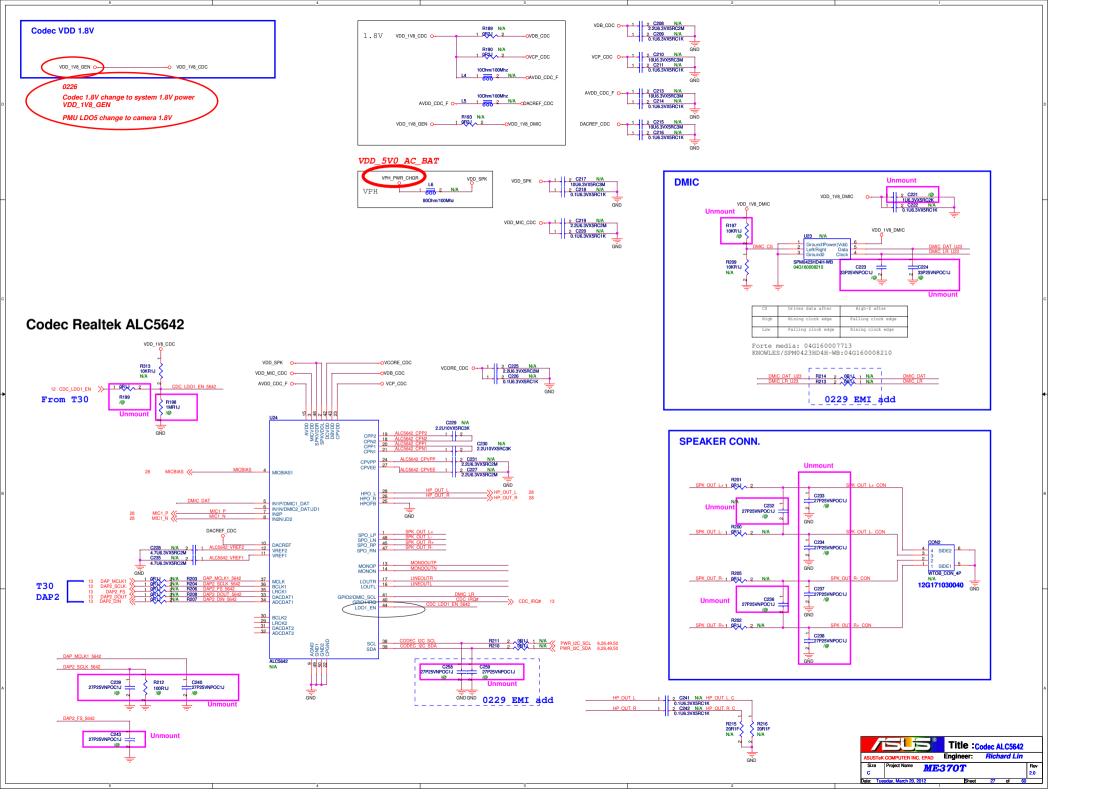


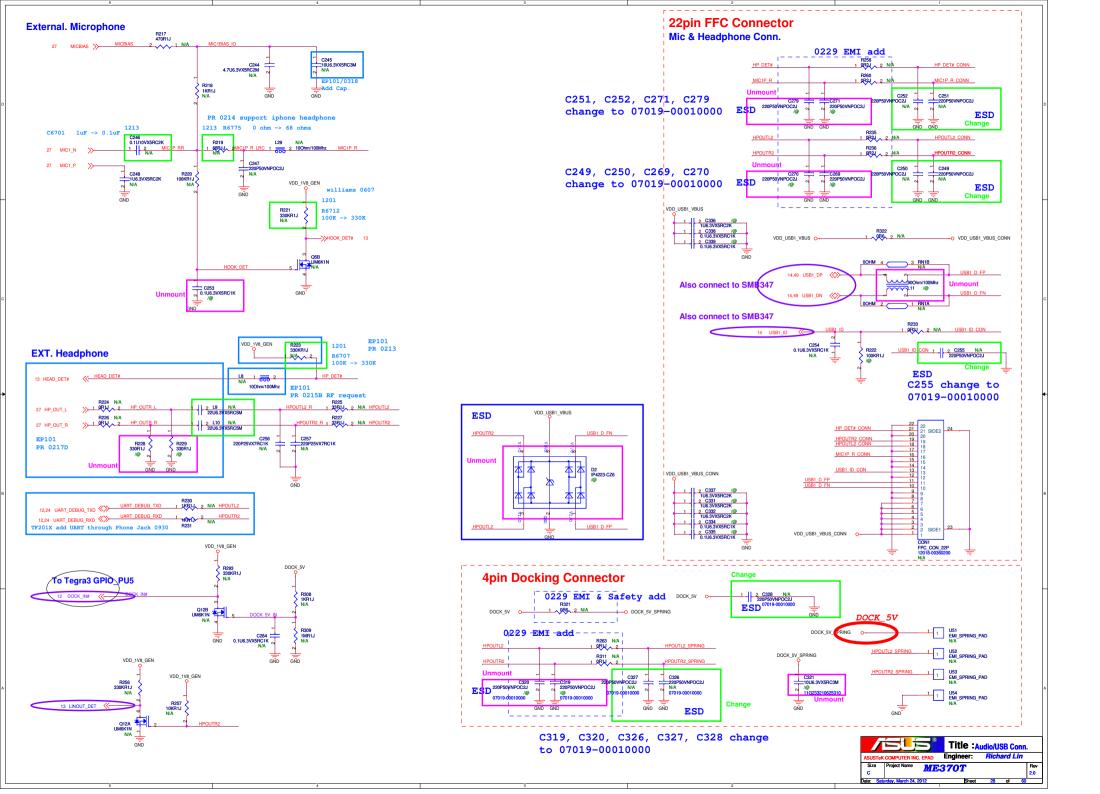
Ambient Light Sensor

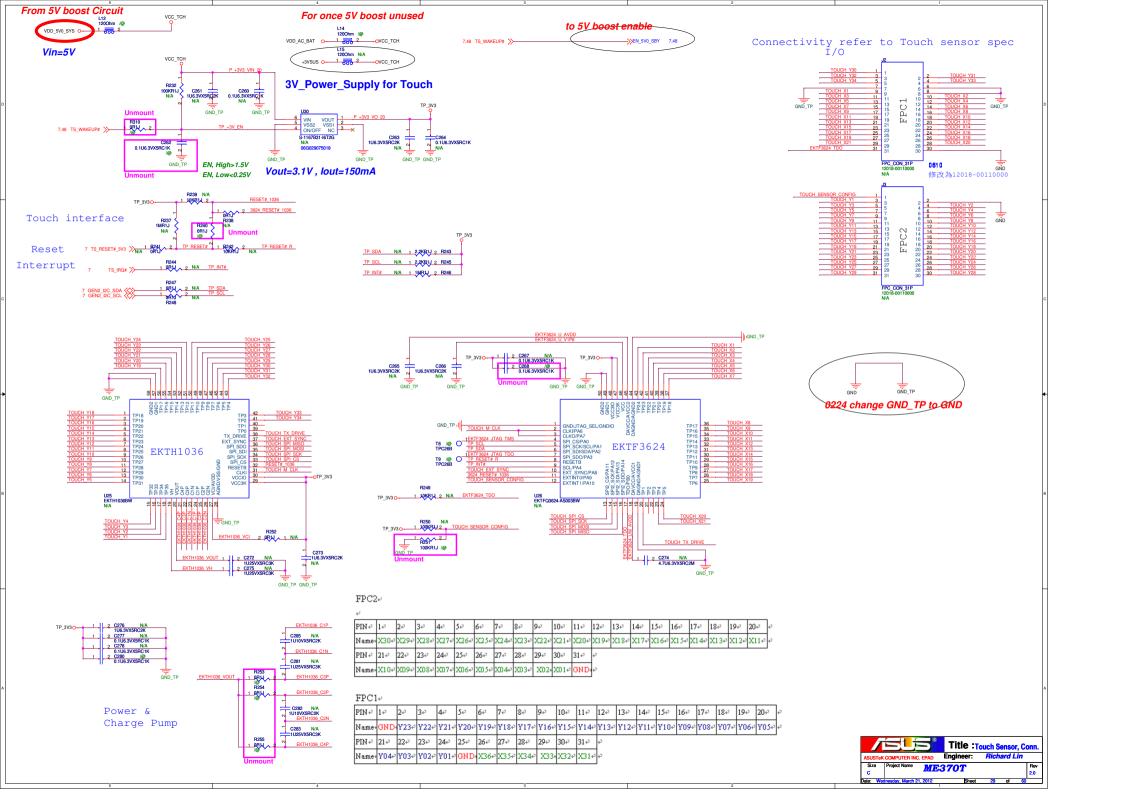


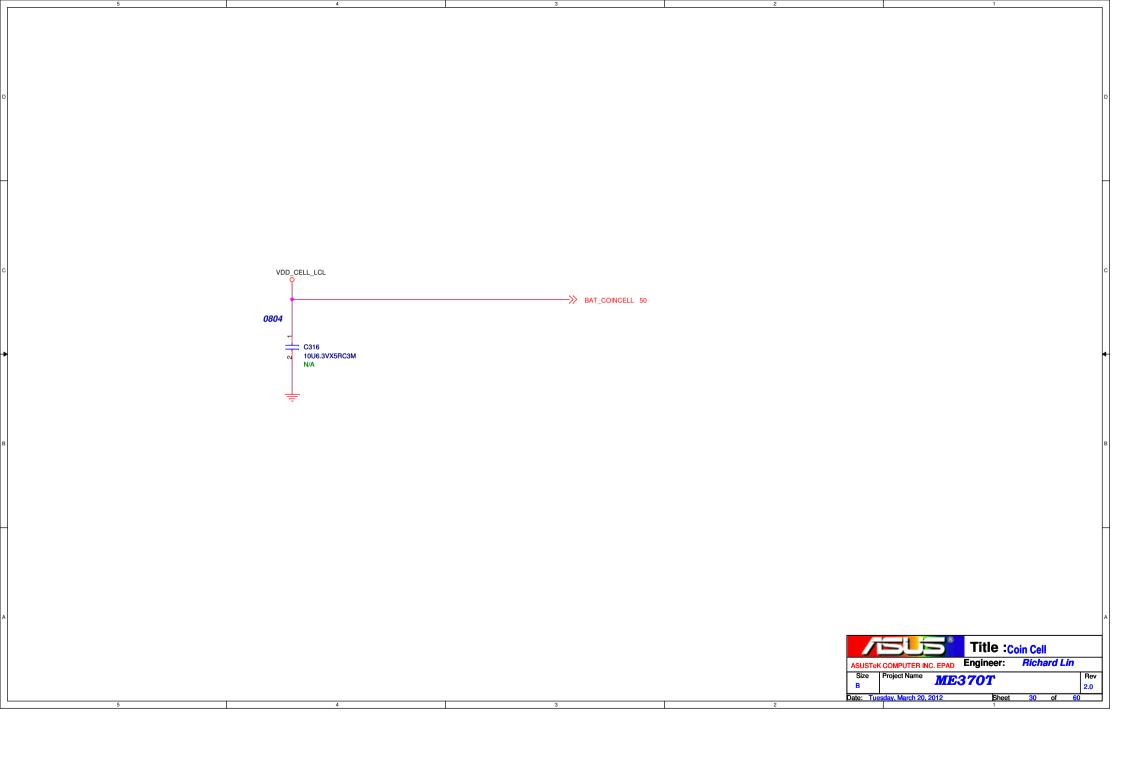


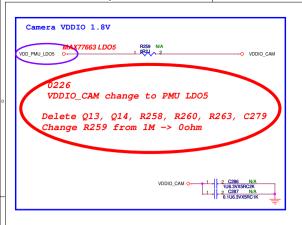


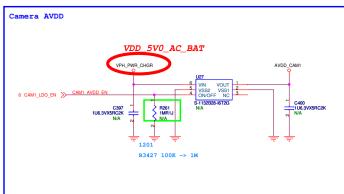


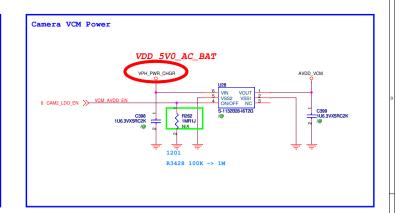








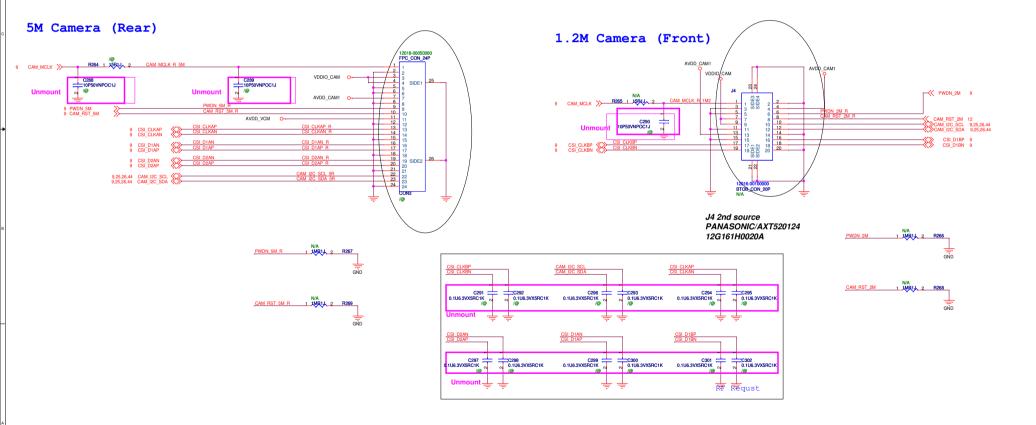


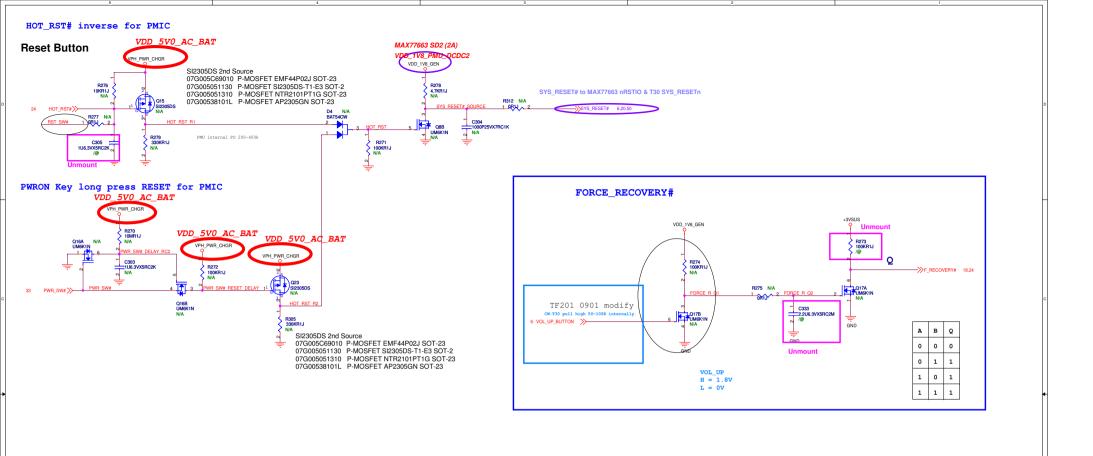


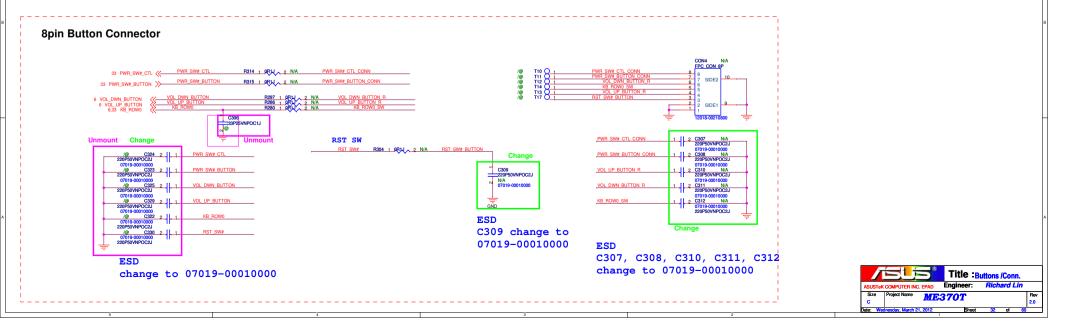
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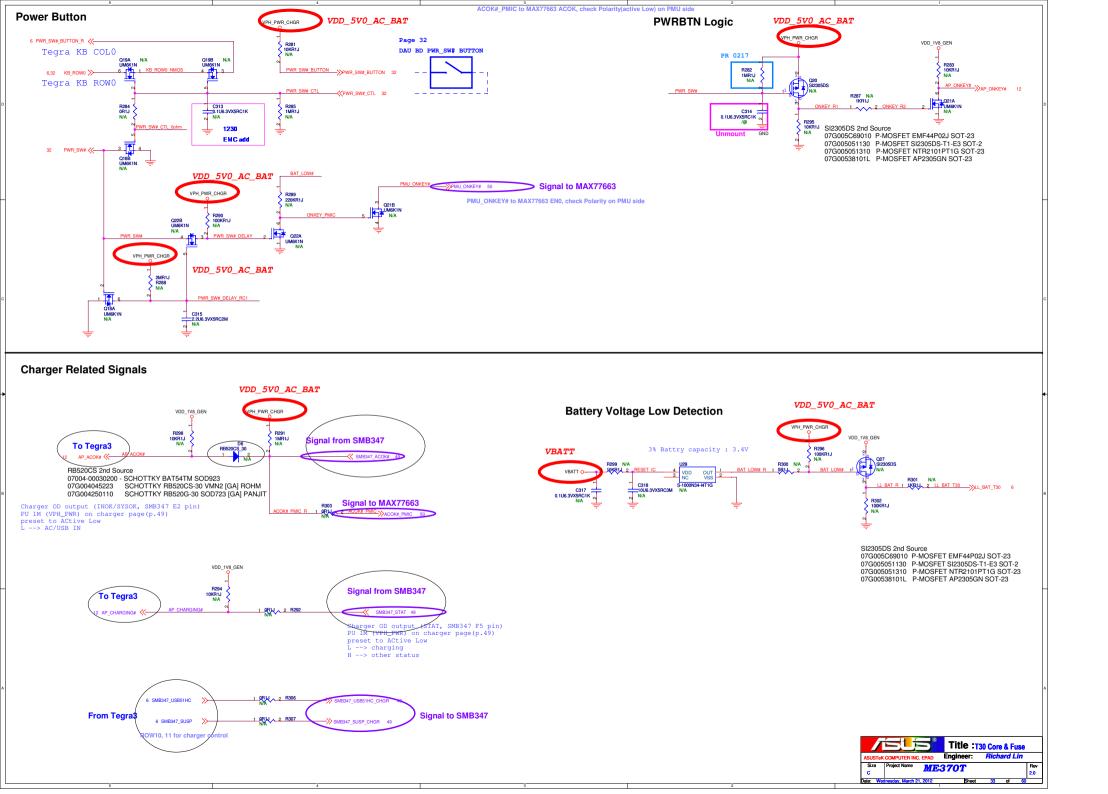
ME370T

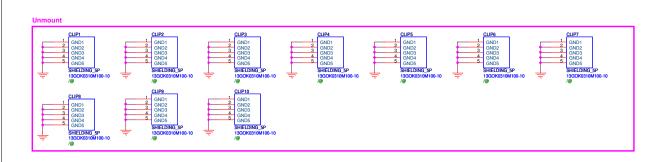
MIPI

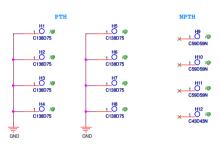


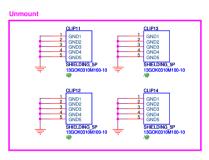






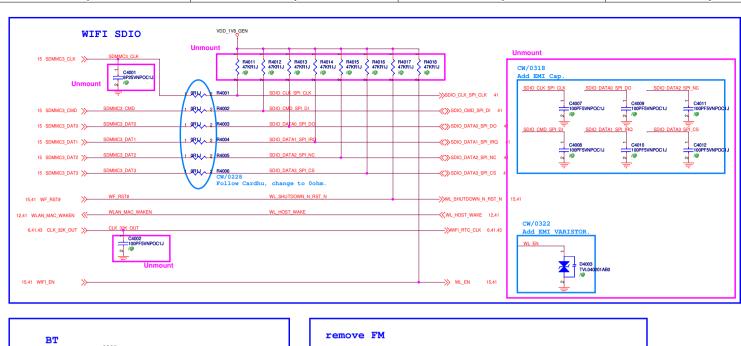


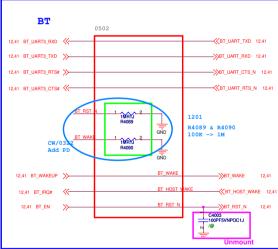


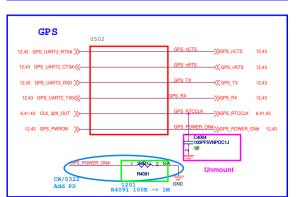




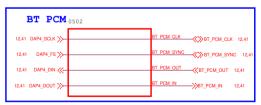






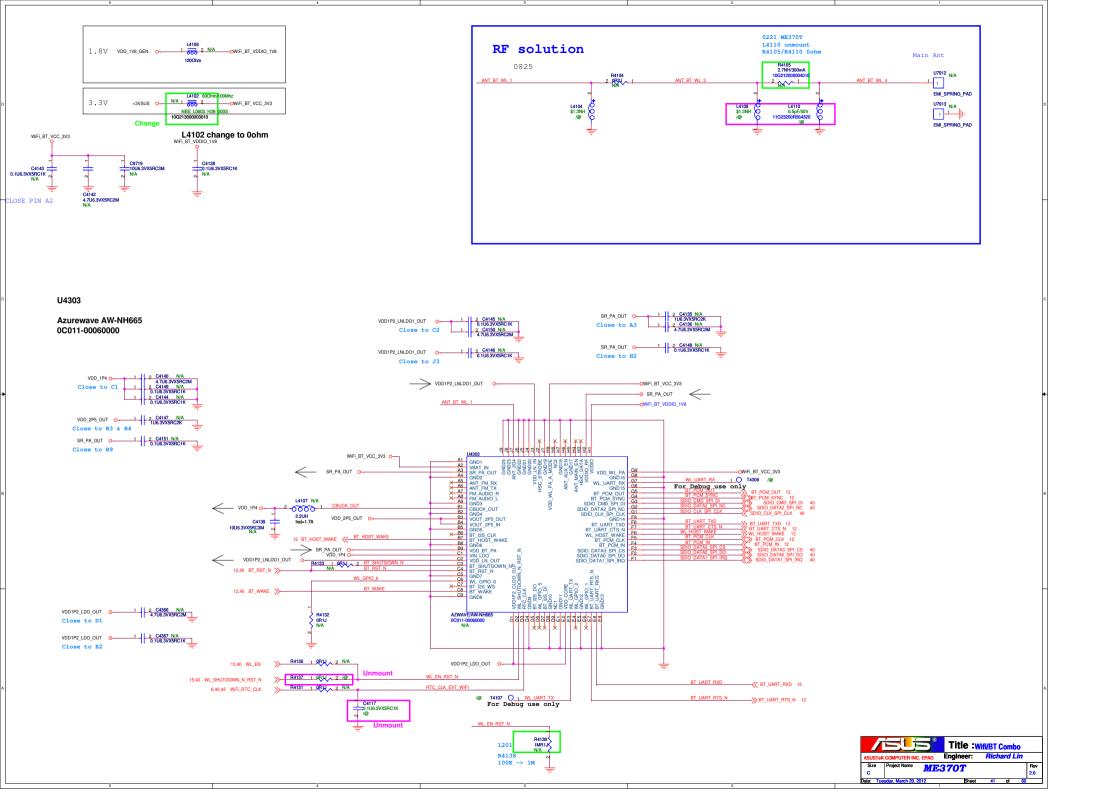


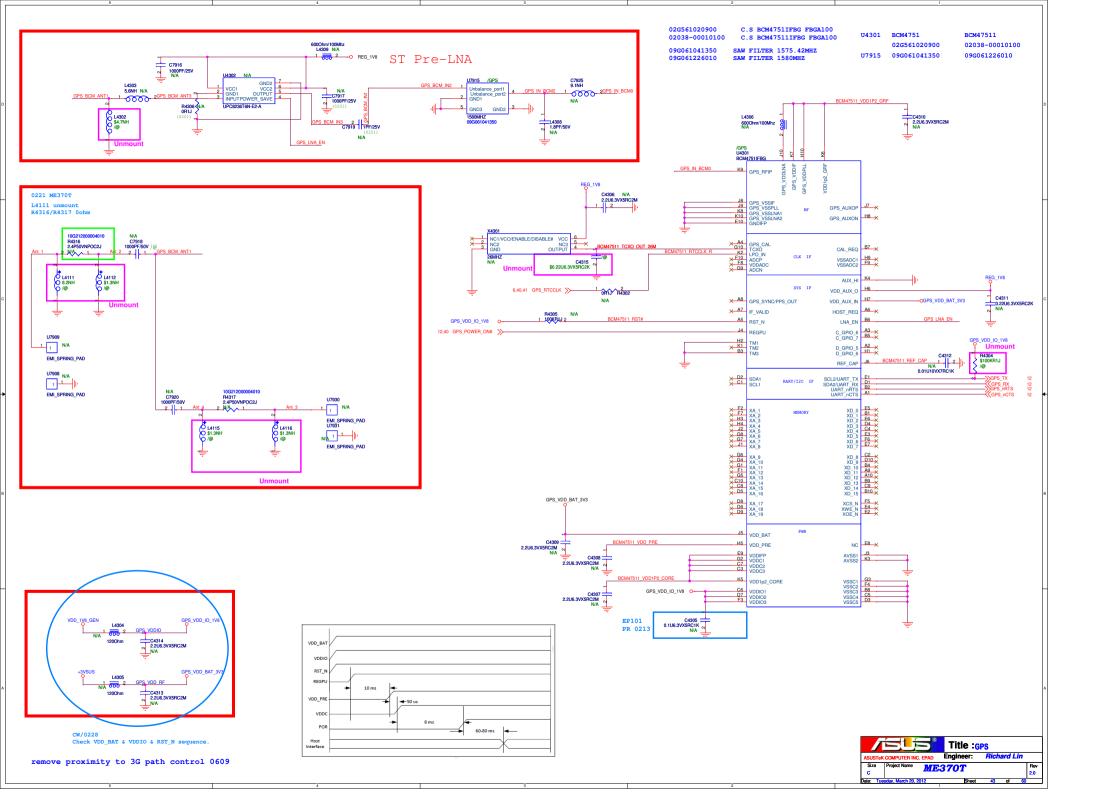
remove FM audio interface,

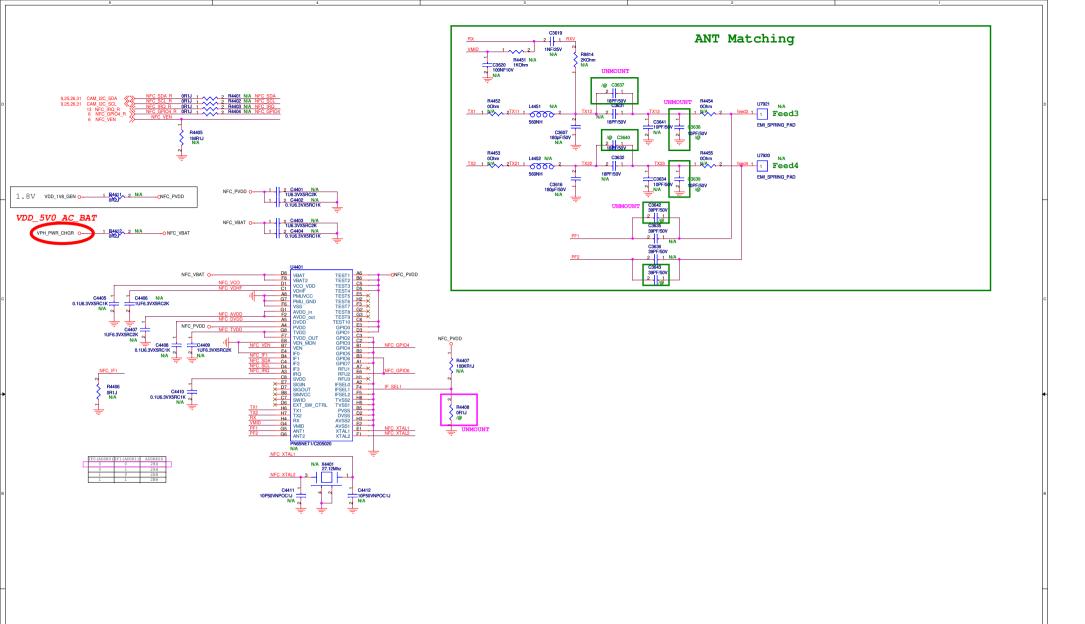


remove proximity to 3G path control 0609

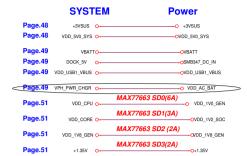




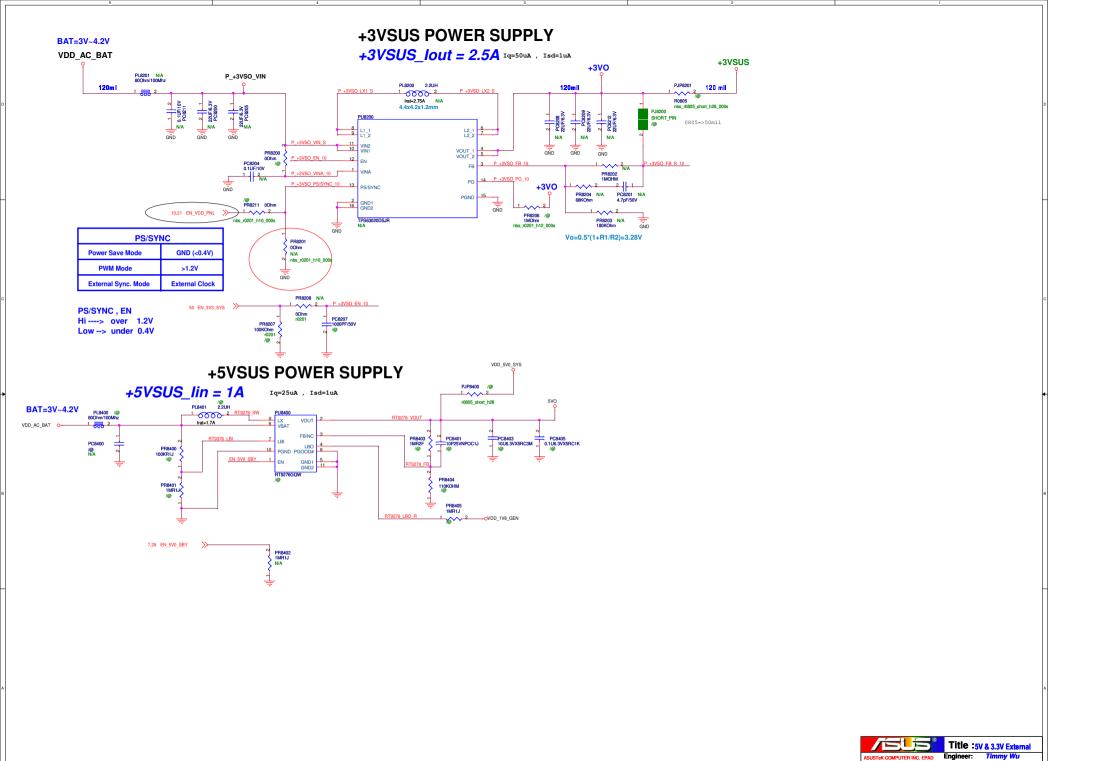




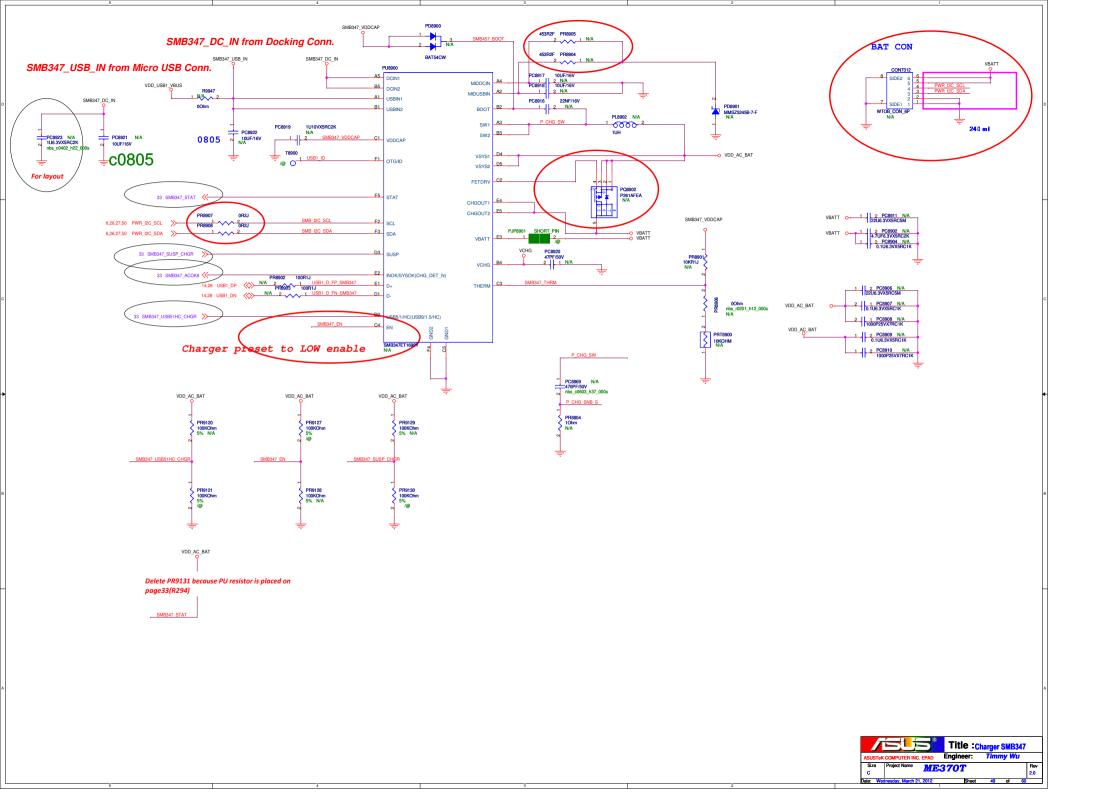
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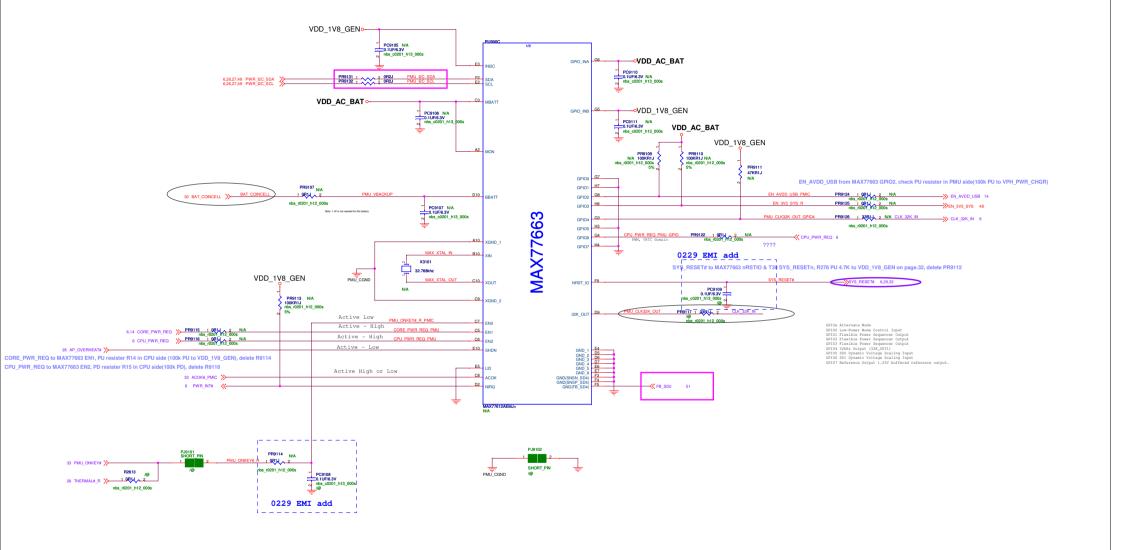






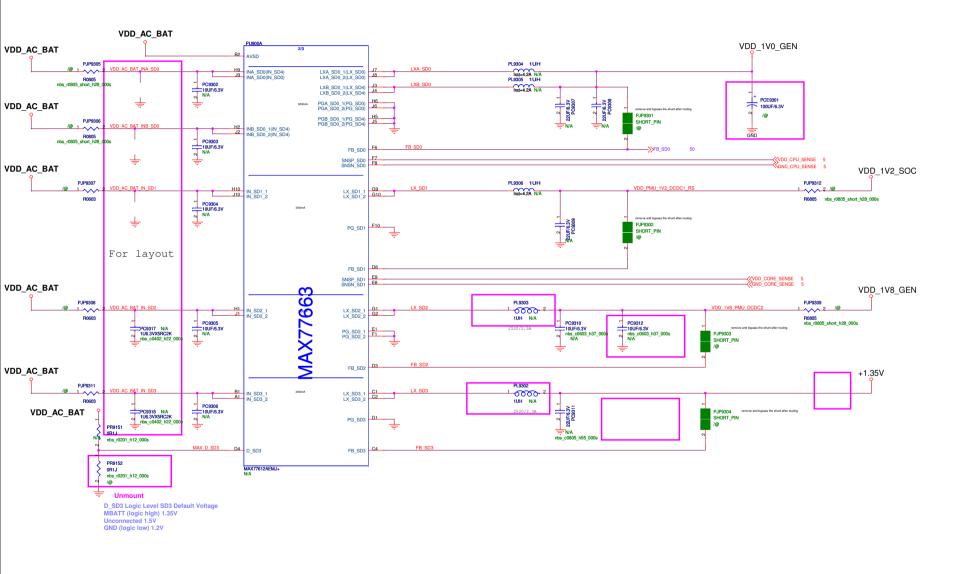
ME370T







Main PMIC Page 2 of 3 (Main DC/DC Converters)





Main PMIC Page 3 of 3 (LDO's)

